

## 800V N-Channel MOSFET

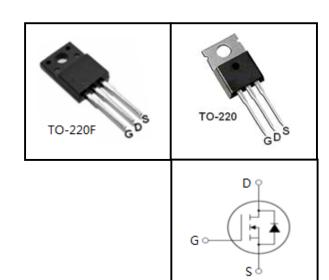
#### **FEATURES**

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

#### **APPLICATIONS**

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

| Device Marking and Package Information |         |         |  |  |
|--|---------|---------|--|--|
| Device                                 | Package | Marking |  |  |
| CS5N80F                                | TO-220F | CS5N80F |  |  |
| CS5N80P                                | TO-220  | CS5N80P |  |  |



| <b>Absolute Maximum Ratings</b> T <sub>C</sub> = 25°C, unless otherwise noted |                                   |          |        |      |  |
|---|-----------------------------------|----------|--------|------|--|
| Parameter   | Symbol                            | Val      | l lmit |      |  |
| Parameter   |                                   | TO-220F  | TO-220 | Unit |  |
| Drain-Source Voltage (V <sub>GS</sub> = 0V)                                   | V <sub>DSS</sub>                  | 800      |        | V    |  |
| Continuous Drain Current  | I <sub>D</sub>                    | 5        |        | А    |  |
| Pulsed Drain Current (note1)  | I <sub>DM</sub>                   | 20       |        | А    |  |
| Gate-Source Voltage   | V <sub>GSS</sub>                  | ±30      |        | V    |  |
| Single Pulse Avalanche Energy (note2)   | E <sub>AS</sub>                   | 151      |        | mJ   |  |
| Avalanche Current (note1)   | I <sub>AS</sub>                   | 5.5      |        | А    |  |
| Repetitive Avalanche Energy (note1)   | E <sub>AR</sub>                   | 90       |        | mJ   |  |
| Power Dissipation (T <sub>C</sub> = 25°C)                                     | P <sub>D</sub>                    | 25       | 70     | W    |  |
| Operating Junction and Storage Temperature Range                              | T <sub>J</sub> , T <sub>stg</sub> | -55~+150 |        | °C   |  |

| Thermal Resistance                      |                   |         |        |        |  |
|---|-------------------|---------|--------|--------|--|
| Borometer                               | Symbol            | Va      | l lmit |        |  |
| Parameter                               |                   | TO-220F | TO-220 | Unit   |  |
| Thermal Resistance, Junction-to-Case    | R <sub>thJC</sub> | 5       | 1.78   | 12/\\\ |  |
| Thermal Resistance, Junction-to-Ambient | R <sub>thJA</sub> | 62.5    | 60     | K/W    |  |



| <b>Specifications</b> $T_J = 25^{\circ}C$ , unless otherwise noted |                     |  |       |      |      |      |  |  |
|--|---------------------|--|-------|------|------|------|--|--|
| Parameter  | Symbol              | T . O . IIV  | Value |      |      |      |  |  |
|  |                     | Test Conditions  | Min.  | Тур. | Max. | Unit |  |  |
| Static   |                     |  |       |      |      |      |  |  |
| Drain-Source Breakdown Voltage                                     | $V_{(BR)DSS}$       | $V_{GS} = 0V, I_D = 250\mu A$  | 800   |      | 1    | ٧    |  |  |
| Zero Gate Voltage Drain Current                                    |                     | $V_{DS} = 800V, V_{GS} = 0V, T_{J} = 25^{\circ}C$                    | -     |      | 1    | μΑ   |  |  |
| Zero Gate Voltage Drain Current                                    | I <sub>DSS</sub>    | $V_{DS} = 640V, V_{GS} = 0V, T_{J} = 125^{\circ}C$                   | ŀ     |      | 100  |      |  |  |
| Gate-Source Leakage  | $I_{\rm GSS}$       | $V_{GS} = \pm 30V$   |       |      | ±100 | nA   |  |  |
| Gate-Source Threshold Voltage                                      | $V_{GS(th)}$        | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                                 | 3.0   |      | 4.0  | V    |  |  |
| Drain-Source On-Resistance (Note3)                                 | R <sub>DS(on)</sub> | $V_{GS} = 10V, I_D = 2.5A$   |       | 2.3  | 2.8  | Ω    |  |  |
| Dynamic  |                     |  |       |      |      |      |  |  |
| Input Capacitance  | $C_{iss}$           | $V_{GS} = 0V,$<br>$V_{DS} = 25V,$                                    |       | 667  |      | pF   |  |  |
| Output Capacitance   | C <sub>oss</sub>    |  |       | 77   |      |      |  |  |
| Reverse Transfer Capacitance                                       | C <sub>rss</sub>    | f = 1.0MHz   |       | 14   |      |      |  |  |
| Total Gate Charge  | $Q_g$               |  |       | 27   |      | nC   |  |  |
| Gate-Source Charge   | $Q_{gs}$            | $V_{DD} = 640 \text{V}, I_{D} = 5 \text{A}, $ $V_{GS} = 10 \text{V}$ |       | 3.5  |      |      |  |  |
| Gate-Drain Charge  | $Q_{gd}$            |  |       | 13   |      |      |  |  |
| Turn-on Delay Time   | t <sub>d(on)</sub>  |  |       | 37   |      | ns   |  |  |
| Turn-on Rise Time  | t <sub>r</sub>      | $V_{DD} = 400V, I_{D} = 5A,$   |       | 15   |      |      |  |  |
| Turn-off Delay Time  | t <sub>d(off)</sub> | $R_G = 25 \Omega$  |       | 144  |      |      |  |  |
| Turn-off Fall Time   | t <sub>f</sub>      |  |       | 41   |      |      |  |  |
| Drain-Source Body Diode Character                                  | istics              |  |       |      |      |      |  |  |
| Continuous Body Diode Current                                      | Is                  | T 05.00  |       |      | 5    | - A  |  |  |
| Pulsed Diode Forward Current                                       | I <sub>SM</sub>     | T <sub>C</sub> = 25 °C   |       |      | 20   |      |  |  |
| Body Diode Voltage   | $V_{SD}$            | $T_J = 25^{\circ}\text{C}, I_{SD} = 2.5\text{A}, V_{GS} = 0\text{V}$ |       |      | 1.4  | V    |  |  |
| Reverse Recovery Time  | t <sub>rr</sub>     | $V_{GS} = 0V, I_{S} = 5A,$   |       | 1099 |      | ns   |  |  |
| Reverse Recovery Charge  | Q <sub>rr</sub>     | di <sub>F</sub> /dt =100A /μs  |       | 3.2  |      | μC   |  |  |

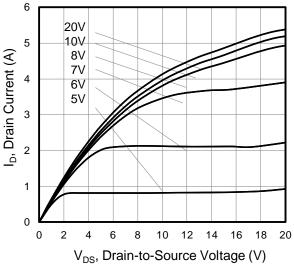
### Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.  $I_{AS} = 3A$ ,  $V_{DD} = 50V$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25 \, ^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%



## **Typical Characteristics** $T_J = 25^{\circ}C$ , unless otherwise noted

Figure 1. Output Characteristics ( $T_J = 25^{\circ}C$ )



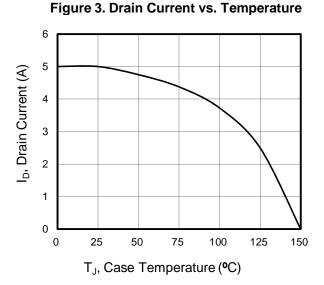


Figure 5. Transfer Characteristics

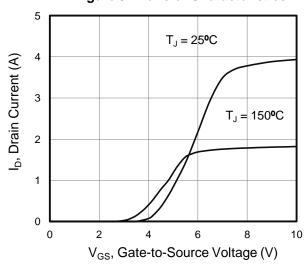


Figure 2. Body Diode Forward Voltage

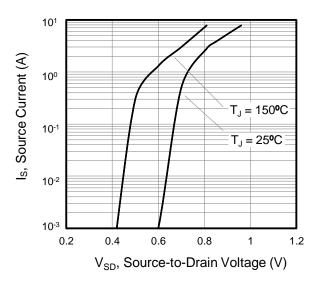


Figure 4. BV<sub>DSS</sub> Variation vs. Temperature

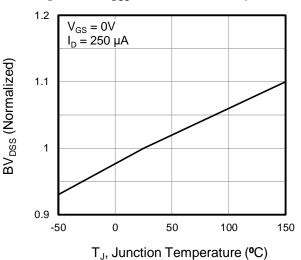
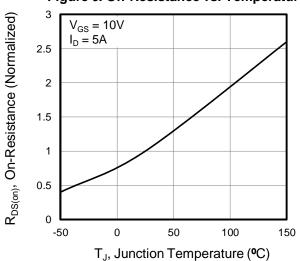


Figure 6. On-Resistance vs. Temperature





### **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

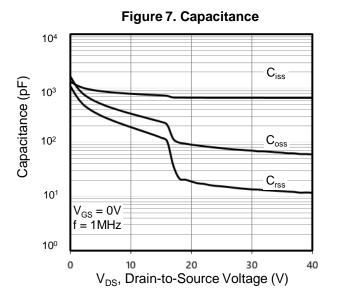


Figure 9. Transient Thermal Impedance

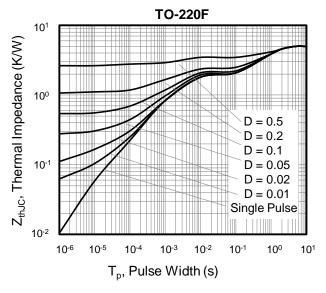


Figure 10. Transient Thermal Impedance

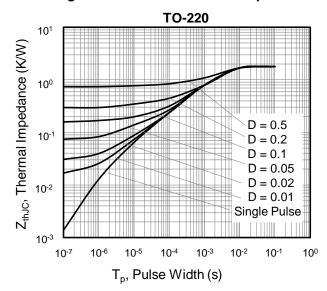




Figure A: Gate Charge Test Circuit and Waveform

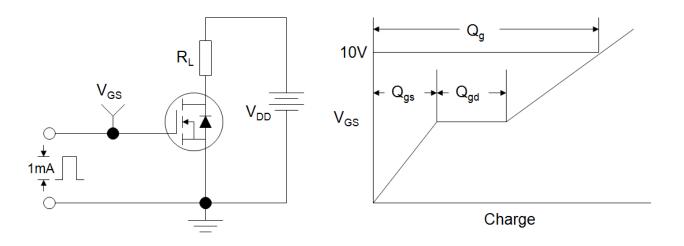


Figure B: Resistive Switching Test Circuit and Waveform

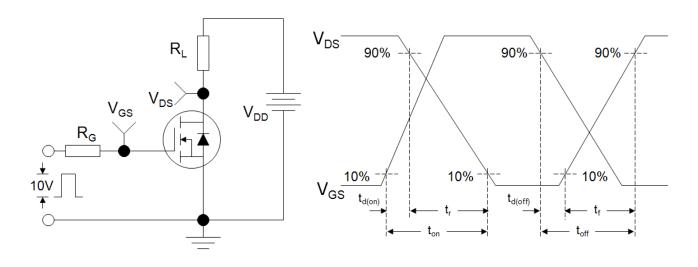
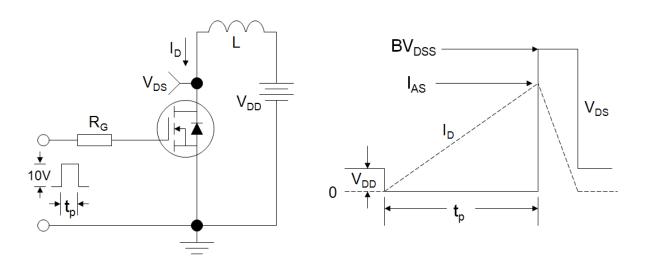
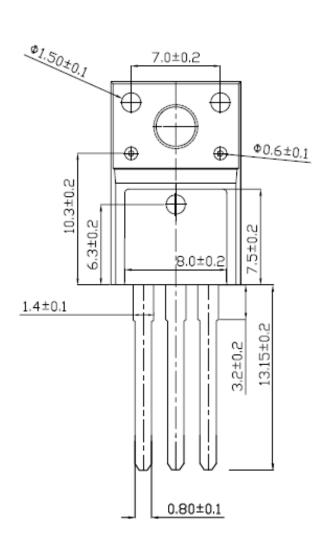


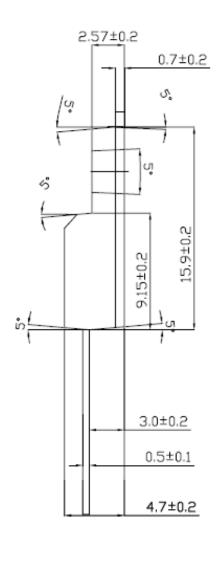
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





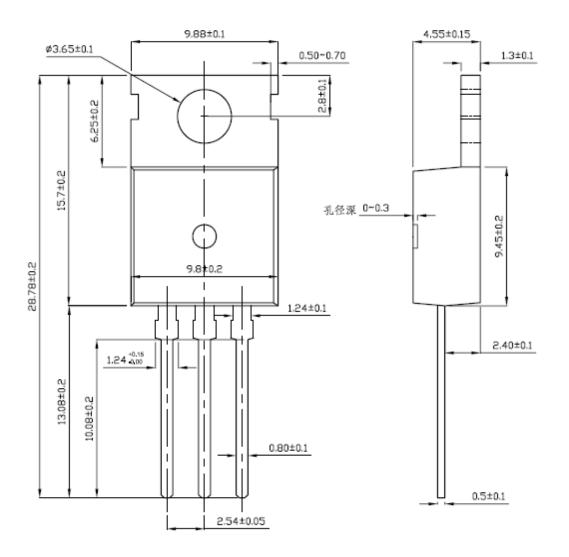
## **TO-220F**







# **TO-220**





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